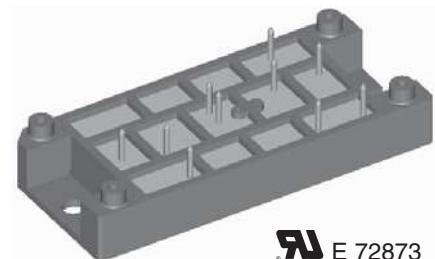
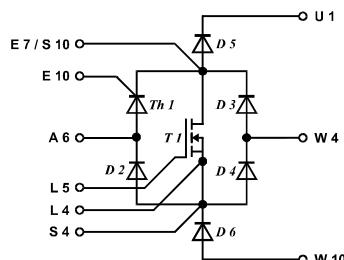


Rectifier Module for Three Phase Power Factor Correction

V_{DSS} = 500 V
I_{D25} = 130 A
R_{DS(on)} = 36 mΩ

Preliminary data

V _{RRM} (FAST Diode)	V _{RRM, DRM} (Diode, Thy.)	V _{DSS} (MOSFET)	Type
V	V	V	
600	500	500	VUM 85-05A



UL E 72873

Symbol	Conditions	Maximum Ratings		
MOSFET T 1				
V _{DSS}	T _{vJ} = 25°C to 150°C	500	V	
V _{DGR}	T _{vJ} = 25°C to 150°C; R _G = 1 MΩ	500	V	
V _{GSM}	Transient	±30	V	
V _{GS}	Continuous	±20	V	
I _D	T _c = 100°C, T _{vJ} = 125°C	60	A	
I _{D25}	T _c = 25°C, T _{vJ} = 150°C	130	A	
I _{DM}	T _c = 25°C, T _{vJ} = 150°C	520	A	
E _{AR}	T _c = 25°C	60	mJ	
P _{tot}	T _c = 25°C	1380	W	
Single Phase Bridge Th1, D2, D3, D4				
V _{RRM, V_{DRM}}		500	V	
I _{DAV}	T _{vJ} = 150°C, T _c = 100°C	47	A	
I _{FSM} , I _{TSM}	T _{vJ} = 45°C, t = 10 ms (50 Hz) t = 8.3 ms (60 Hz)	320	A	
	T _{vJ} = 150°C, t = 10 ms (50 Hz) t = 8.3 ms (60 Hz)	340	A	
P _{tot}	T _c = 25°C; per diode	280	A	
W		300	A	
Fast Diodes D5, D6				
V _{RRM}		600	V	
I _{FAV}	T _{vJ} = 150°C, T _c = 100°C, rectangular δ = 0.5	31	A	
I _{FSM}	T _{vJ} = 45°C, t = 10 ms (50 Hz)	250	A	
P _{tot}	T _c = 25°C	95	W	
Module				
T _{vJ}		-40...+150	°C	
T _{JM}		150	°C	
T _{stg}		-40...+125	°C	
V _{ISOL}	I _{ISOL} ≤ 1 mA	50/60 Hz	3600	V~
M _d	Mounting torque (M5)		2-2.5/18-22	Nm/lb.in.
Weight		80	g	

Features

- Package with DCB ceramic base plate
- Soldering connections for PCB mounting
- Isolation voltage 3600 V~
- Low R_{DS(on)} HDMOS™ process
- Low package inductance for high speed switching
- Ultrafast diodes
- Kelvin source for easy drive
- UL recognized

Applications

- Three phase PFC by Kolar circuit
- Three phase input rectifier with power factor correction consisting of three modules VUM 85-05
- For power supplies, UPS, SMPS, drives, welding etc.

Advantages

- Reduced harmonic content of input currents corresponding to standards
- Rectifier generates maximum DC power with a given AC fuse
- Wide input voltage range
- No external isolation
- Easy to mount with two screws
- Suitable for wave soldering
- High temperature and power cycling capability

Symbol	Conditions	Characteristic Values			
		($T_{VJ} = 25^\circ C$, unless otherwise specified)	min.	typ.	max.
MOSFET T 1					
$V_{GS(th)}$	$V_{DS} = \pm 20 V$, $I_D = 30 mA$	2	3	4	V
I_{GSS}	$V_{GS} = \pm 20 V$, $V_{DS} = 0 V$			± 1.5	μA
I_{DSS}	$V_{DS} = V_{DSS}$, $V_{GS} = 0 V$ $V_{DS} = 0.8 \cdot V_{DSS}$, $V_{GS} = 0 V$, $T_{VJ} = 125^\circ C$	0.5 1	1.4 7	mA	
$R_{DS(on)}$	$I_D = \frac{1}{2} I_{D25}$, $V_{GS} = 10 V$, pulse test $t \leq 300 \mu s$, $d \leq 2\%$			36	$m\Omega$
g_{fs}	$V_{DS} = 10 V$, $I_D = \frac{1}{2} I_{D25}$, $t = < 300 \mu s$	75	145		S
$t_{d(on)}$ t_r $t_{d(off)}$ t_f	$V_{DS} = \frac{1}{2} V_{DSS}$, $I_D = \frac{1}{2} I_{D25}$, $V_{GS} = 15 V$ $R_G = 1 \Omega$, $L = 100 \mu H$, $T_{VJ} = 125^\circ C$	16 33 65 30	25 45 80 40	ns	
C_{iss} C_{oss} C_{rss}	$V_{DS} = 25 V$, $f = 1 MHz$, $V_{GS} = 0 V$	30 3 1		nF nF nF	
Q_g Q_{gs} Q_g	$V_{DS} = \frac{1}{2} V_{DSS}$, $I_D = \frac{1}{2} I_{D25}$, $V_{GS} = 15 V$	945 195 435	1120 280 595	nC nC nC	
R_{thJC} R_{thCH}		0.05	0.09 K/W	K/W	
Single Phase Bridge Th1, D2, D3, D4					
V_F , V_T	I_F , $I_T = 45 A$, $T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$		1.50 1.55	V	
I_{RRM} , I_{DRM}	V_D , $V_R = V_{DRM}$, V_{RRM} , $T_{VJ} = 25^\circ C$ V_D , $V_R = 0.8 \cdot V_{DRM}$, V_{RRM} , $T_{VJ} = 125^\circ C$	0.5 1	1.4 7	mA	
V_{T0} r_T	For power-loss calculations only $T_{VJ} = 150^\circ C$		0.85 14	V $m\Omega$	
V_{GT} I_{GT}	$V_D = 6 V$		1.5 100	V mA	
V_{GD} I_{GD}	$V_D = \frac{2}{3} V_{DRM}$, $T_{VJ} = 150^\circ C$		0.2 5	V mA	
V_{RGM}			10	V	
I_H	$V_D = 6 V$, $R_{GK} = \infty$		200	mA	
I_L	$I_G = 0.45 A$, $di_G/dt = 0.45 A/\mu s$, $t_p = 10 \mu s$		450	mA	
$(di/dt)_{cr}$	$I_G = 0.45 A$, $di_G/dt = 0.45 A/\mu s$, $t_p = 200 \mu s$, $f = 50 Hz$ $V_D = \frac{2}{3} V_{DRM}$, $T_{VJ} = 150^\circ C$, $I_T = 45 A$, repetitive		150	A/ μs	
	$I_G = 0.45 A$, $di_G/dt = 0.45 A/\mu s$, $t_p = 200 \mu s$, $f = 50 Hz$ $V_D = \frac{2}{3} V_{DRM}$, $T_{VJ} = 150^\circ C$, $I_T = I_{DAV}$, non-repetitive		500	A/ μs	
t_{gd}	$I_G = 0.45 A$, $di_G/dt = 0.45 A/\mu s$, $V_D = \frac{1}{2} V_{DRM}$		2	μs	
t_q	$I_T = 20 A$, $di/dt = -10 A/\mu s$, $V_R = 100 V$, $V_D = \frac{2}{3} V_{DRM}$ $t_p = 200 \mu s$, $dv/dt = 15 V/\mu s$, $T_{VJ} = 150^\circ C$	150		μs	
P_{GM}	$I_T = I_{d(AV)}$, $T_{VJ} = 150^\circ C$	$t_p = 30 \mu s$ $t_p = 300 \mu s$	10 5 0.5	W	
P_{GAVM}				W	
R_{thJC} R_{thCH}	DC per diode / thyristor DC per diode / thyristor		0.4	1.3 K/W	K/W

Symbol	Conditions	Characteristic Values		
		$(T_{VJ} = 25^\circ C$, unless otherwise specified)		
		min.	typ.	max.
Fast Diodes D 5, D 6				
V_F	$I_F = 30 A$; $T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$		2.70	V
			1.85	V
I_R	$V_R = 600 V$, $T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$		0.5	mA
			1	mA
V_{TO}	For power-loss calculations only		1.23	V
r_T	$T_{VJ} = 150^\circ C$		9.8	mΩ
I_{RM}	$I_F = 50 A$; $di/dt = 100 A/\mu s$ $V_R = 100 V$, $T_{VJ} = 100^\circ C$	3	3.5	A
t_{rr}	$I_F = 1 A$, $V_R = 30 V$, $di/dt = 200 A/\mu s$	25	30	ns
R_{thJC}	DC per diode		1.3	K/W
R_{thCH}	DC per diode	0.4		K/W

Dimensions in mm (1 mm = 0.0394")

